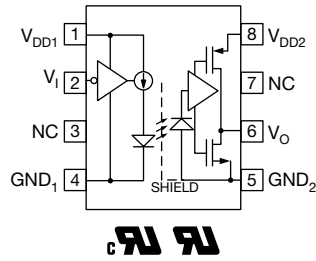
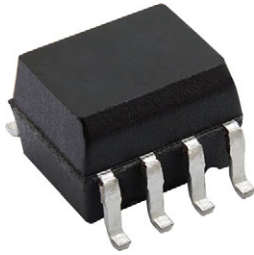


## High Speed Optocoupler, 25 MBd, SOIC-8 Package



### FEATURES

- CMOS logic digital input and output
- High speed data rate of 25 MBd
- Wide supply voltage range 2.7 V to 5.5 V
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

### DESCRIPTION

The VOIH72A is a single channel 25 MBd high speed optocoupler in CMOS technology. Utilizing an input LED driver with a high speed IRED coupled with an integrated optical detector IC. A true digital input and output interface, in combination with the very low pulse width distortion of max. 6 ns and a high noise immunity of minimum 20 kV/μs enable an easy integration into digital logic systems.

### APPLICATIONS

- Galvanic isolation in digital systems
- Ground loop elimination
- Digital bus system isolation
- PLC and ATE interface isolation
- Feedback control in digital power supplies

### AGENCY APPROVALS

- UL 1577 (pending)
- cUL 1577 (pending)

ORDERING INFORMATION																										
<table border="1" style="display: inline-table; border-collapse: collapse;"> <tr> <td>V</td><td>O</td><td>I</td><td>H</td><td>7</td><td>2</td><td>A</td><td>-</td><td>X</td><td>0</td><td>0</td><td>1</td><td>T</td> </tr> <tr> <td colspan="7" style="text-align: center;">PART NUMBER</td> <td colspan="4" style="text-align: center;">PACKAGE OPTION</td> <td style="text-align: center;">TAPE AND REEL</td> </tr> </table>	V	O	I	H	7	2	A	-	X	0	0	1	T	PART NUMBER							PACKAGE OPTION				TAPE AND REEL	
V	O	I	H	7	2	A	-	X	0	0	1	T														
PART NUMBER							PACKAGE OPTION				TAPE AND REEL															
<b>AGENCY CERTIFIED / PACKAGE</b>																										
<b>UL, cUL</b>																										
SOIC-8	VOIH72AT																									

#### Note

- Additional options may be possible, please contact sales office

TRUTH TABLE (positive logic)	
INPUT	OUTPUT
H	H
L	L



<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
<b>INPUT</b>				
Supply voltage		$V_{DD1}$	-0.5 to 6.0	V
Input voltage		$V_I$	-0.5 to $V_{DD1} + 0.5$	V
Input current		$I_I$	15	mA
Input power dissipation		$P_{diss}$	100	mW
<b>OUTPUT</b>				
Supply voltage		$V_{DD2}$	-0.5 to 6.0	V
Output voltage		$V_O$	-0.5 to $V_{DD2} + 0.5$	V
Output current		$I_O$	10	mA
Output power dissipation		$P_{diss}$	50	mW
<b>COUPLER</b>				
Isolation test voltage	t = 1 min	$V_{ISO}$	3750	$V_{RMS}$
Storage temperature		$T_{stg}$	-55 to +150	$^{\circ}\text{C}$
Operating temperature		$T_{amb}$	-40 to +110	$^{\circ}\text{C}$
Lead solder temperature	for 10 s		260	$^{\circ}\text{C}$
Solder reflow temperature	for 1 min		260	$^{\circ}\text{C}$

**Note**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

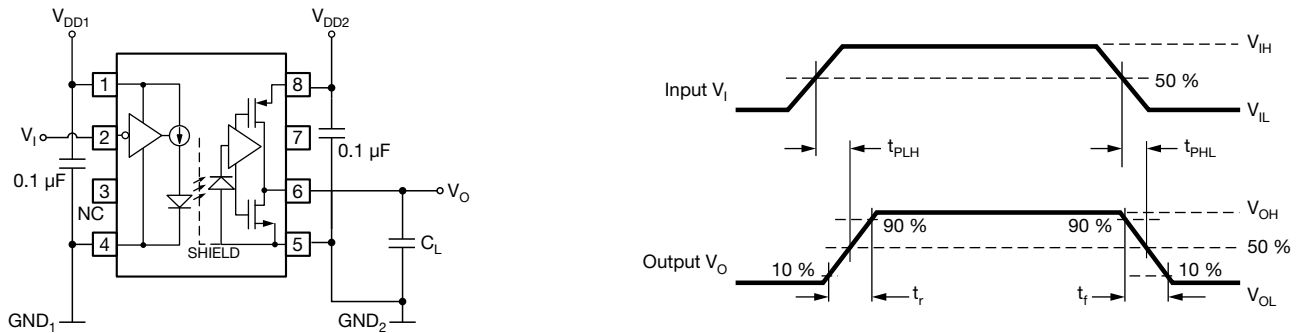
<b>RECOMMENDED OPERATING CONDITION</b>					
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT
Operating temperature		$T_{amb}$	-40	+110	$^{\circ}\text{C}$
Input supply voltage		$V_{DD1}$	2.7	5.5	V
Output supply voltage		$V_{DD2}$	2.7	5.5	V
Logic low input voltage		$V_{IL}$	0	0.8	V
Logic high input level		$V_{IH}$	2.0	$V_{DD1}$	V

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+110\text{ }^{\circ}\text{C}$ , $2.7\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$ , unless otherwise specified; typical values are at $V_{DD1} = V_{DD2} = 3.3\text{ V}$ , $T_{amb} = 25\text{ }^{\circ}\text{C}$ )						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>						
Input current		$I_I$	-10	-	10	$\mu\text{A}$
High level supply current		$I_{DD1H}$	-	0.65	5	mA
Low level supply current		$I_{DD1L}$	-	9	15	mA
<b>OUTPUT</b>						
High level supply current		$I_{DD2H}$	-	1.3	2	mA
Low level supply current		$I_{DD2L}$	-	1.2	2	mA
High level output voltage	$V_I = V_{IH}$ , $I_O = -20\text{ }\mu\text{A}$	$V_{OH}$	$V_{DD2} - 0.4$	$V_{DD2}$	-	V
	$V_I = V_{IH}$ , $I_O = -4\text{ mA}$	$V_{OH}$	$V_{DD2} - 1.4$	$V_{DD2} - 0.4$	-	V
Low level output voltage	$V_I = V_{IL}$ , $I_O = 20\text{ }\mu\text{A}$	$V_{OL}$	-	0	0.1	V
	$V_I = V_{IL}$ , $I_O = 4\text{ mA}$	$V_{OL}$	-	0.16	0.6	V

**Note**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

<b>SWITCHING CHARACTERISTICS</b> ( $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+110\text{ }^{\circ}\text{C}$ , $2.7\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$ , unless otherwise specified; typical values are at $V_{DD1} = V_{DD2} = 3.3\text{ V}$ , $T_{amb} = 25\text{ }^{\circ}\text{C}$ )						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Propagation delay time to high output level	$C_L = 15\text{ pF}$ , $V_{IL} = 0\text{ V}$ , $V_{IH} = V_{DD1}$	$t_{PLH}$	-	29	40	ns
Propagation delay time to low output level	$C_L = 15\text{ pF}$ , $V_{IL} = 0\text{ V}$ , $V_{IH} = V_{DD1}$	$t_{PHL}$	-	24	40	ns
Pulse width distortion	$C_L = 15\text{ pF}$ , $V_{IL} = 0\text{ V}$ , $V_{IH} = V_{DD1}$	$ t_{PLH} - t_{PHL} $	-	2	6	ns
Propagation delay skew	$C_L = 15\text{ pF}$ , $V_{IL} = 0\text{ V}$ , $V_{IH} = V_{DD1}$	$t_{PSK}$	-	5.8	20	ns
Output rise time (10 to 90 %)	$C_L = 15\text{ pF}$ , $V_{IL} = 0\text{ V}$ , $V_{IH} = V_{DD1}$	$t_r$	-	3.3	-	ns
Output fall time (90 to 10 %)	$C_L = 15\text{ pF}$ , $V_{IL} = 0\text{ V}$ , $V_{IH} = V_{DD1}$	$t_f$	-	3.1	-	ns


 Fig. 1 - Test Circuit for  $t_{PLH}$ ,  $t_{PHL}$ ,  $t_r$  and  $t_f$ 

<b>COMMON MODE TRANSIENT IMMUNITY</b> ( $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+110\text{ }^{\circ}\text{C}$ , $2.7\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$ , unless otherwise specified; typical values are at $V_{DD1} = V_{DD2} = 3.3\text{ V}$ , $T_{amb} = 25\text{ }^{\circ}\text{C}$ )						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Common mode transient immunity (high)	$V_{CM} = 1000\text{ V}$ , $V_I = V_{DD1}$ , $V_O > 0.8 \times V_{DD2}$	$ CM_H $	20 000	50 000	-	V/ $\mu\text{s}$
Common mode transient immunity (low)	$V_{CM} = 1000\text{ V}$ , $V_I = 0\text{ V}$ , $V_O < 0.8\text{ V}$	$ CM_L $	20 000	30 000	-	V/ $\mu\text{s}$

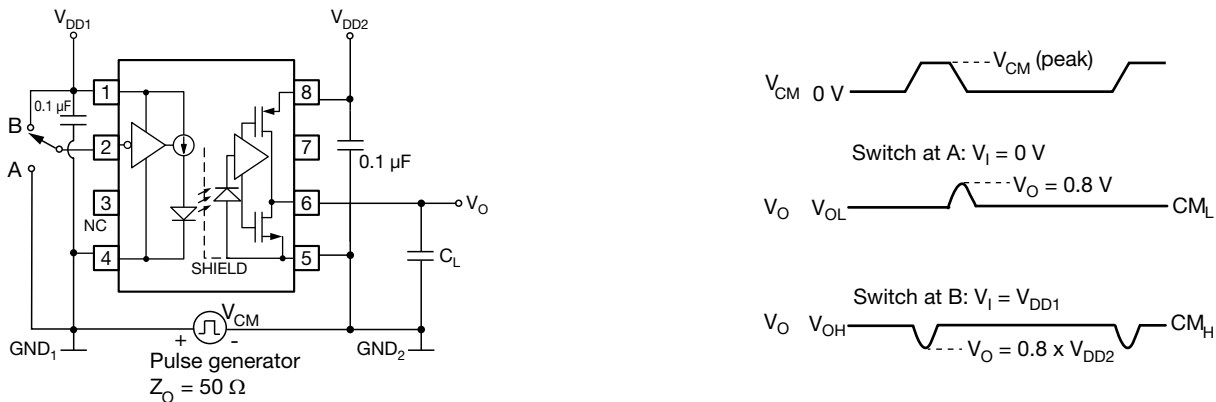


Fig. 2 - Test Circuit for Common Mode Transient Immunity

SAFETY AND INSULATION RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 110 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL 1577, t = 1 min	V <sub>ISO</sub>	3750	VRMS
Maximum transient isolation voltage	according to DIN EN 60747-5-5	V <sub>IOTM</sub>	6000	V <sub>peak</sub>
Maximum repetitive peak isolation voltage	according to DIN EN 60747-5-5	V <sub>IORM</sub>	560	V <sub>peak</sub>
Isolation resistance	T <sub>amb</sub> = 25 °C, V <sub>IO</sub> = 500 V	R <sub>IO</sub>	≥ 10 <sup>12</sup>	Ω
	T <sub>amb</sub> = 110 °C, V <sub>IO</sub> = 500 V	R <sub>IO</sub>	≥ 10 <sup>11</sup>	Ω
	T <sub>amb</sub> = 165 °C, V <sub>IO</sub> = 500 V	R <sub>IO</sub>	≥ 10 <sup>9</sup>	Ω
Output safety power		P <sub>SO</sub>	350	mW
Input safety current		I <sub>SI</sub>	150	mA
Input safety temperature		T <sub>S</sub>	165	°C
Creepage distance			≥ 4	mm
Clearance distance			≥ 4	mm
Insulation thickness		DTI	≥ 0.2	mm
Input to output test voltage, method B	V <sub>IORM</sub> × 1.875 = V <sub>PR</sub> , 100 % production test with t <sub>M</sub> = 1 s, partial discharge < 5 pC	V <sub>PR</sub>	1050	V <sub>peak</sub>
Input to output test voltage, method A	V <sub>IORM</sub> × 1.6 = V <sub>PR</sub> , 100 % sample test with t <sub>M</sub> = 10 s, partial discharge < 5 pC	V <sub>PR</sub>	896	V <sub>peak</sub>

**Note**

- As per IEC 60747-5-5, 7.4.3.8.1, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of productive circuits.

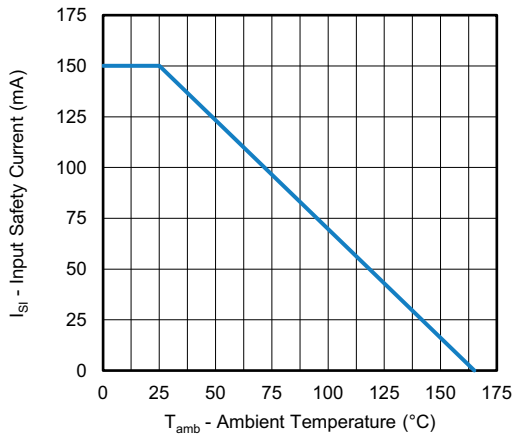


Fig. 3 - Input Safety Current vs. Ambient Temperature

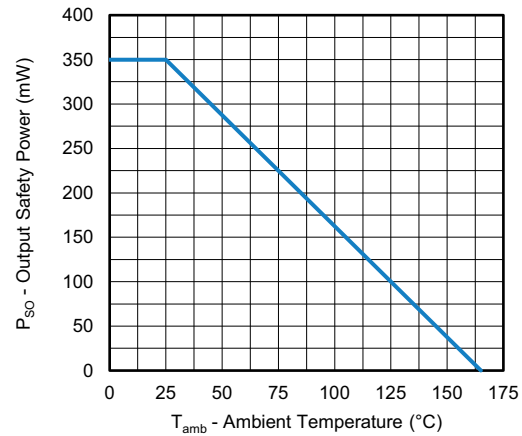


Fig. 4 - Output Safety Power vs. Ambient Temperature

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

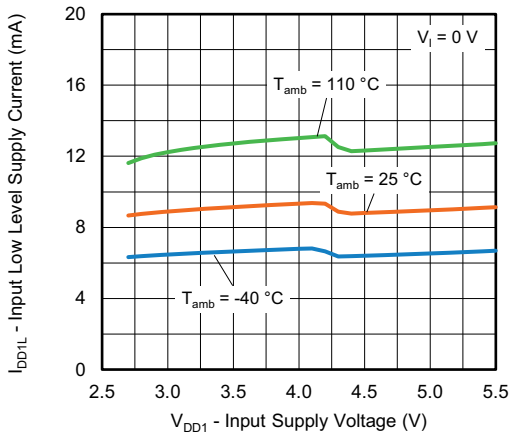


Fig. 5 - Input Low Level Supply Current vs. Input Supply Voltage

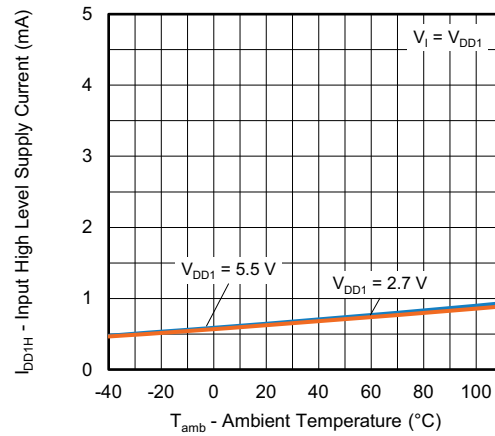


Fig. 8 - Input High Level Supply Current vs. Ambient Temperature

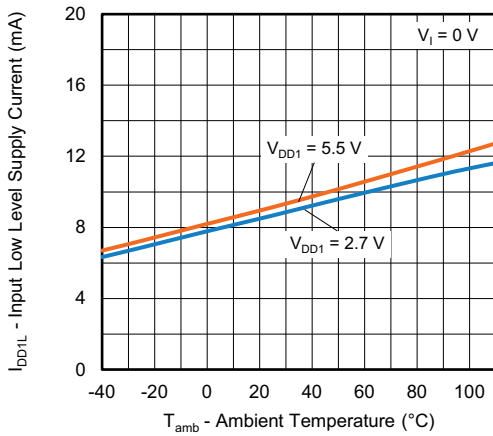


Fig. 6 - Input Low Level Supply Current vs. Ambient Temperature

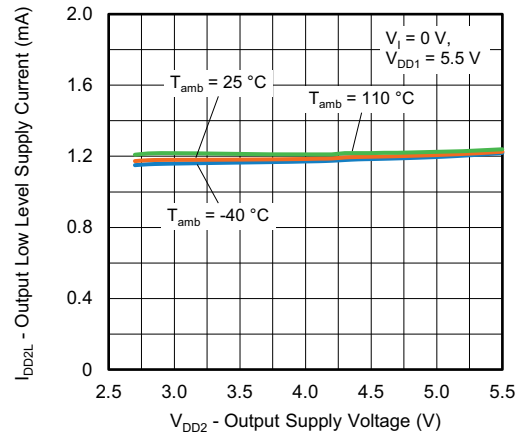


Fig. 9 - Output Low Level Supply Current vs. Output Supply Voltage

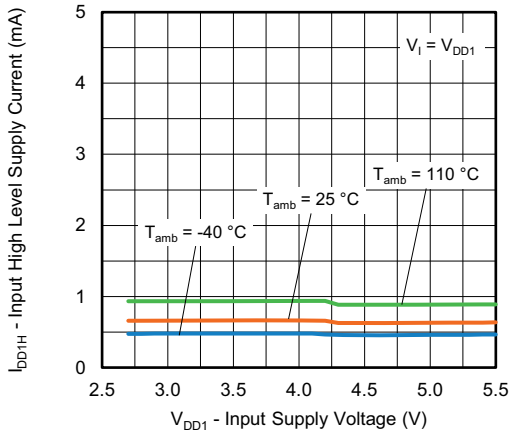


Fig. 7 - Input High Level Supply Current vs. Input Supply Voltage

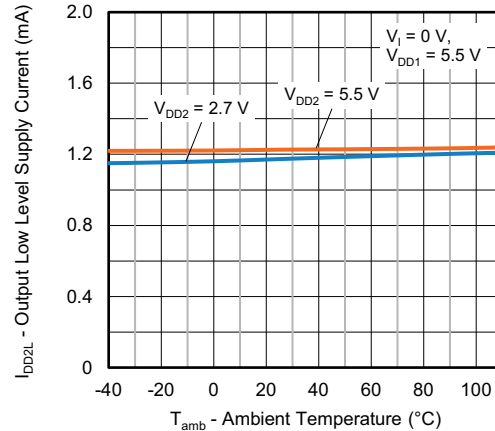


Fig. 10 - Output Low Level Supply Current vs. Ambient Temperature

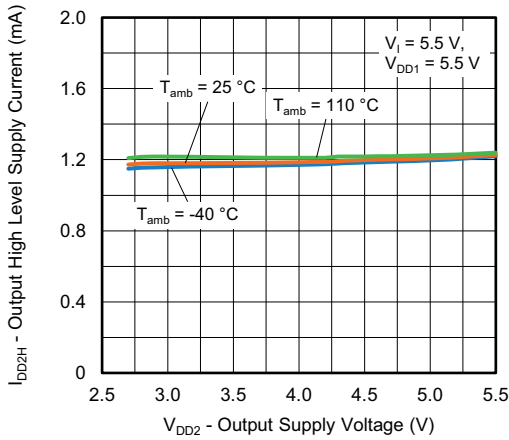


Fig. 11 - Output High Level Supply Current vs. Output Supply Voltage

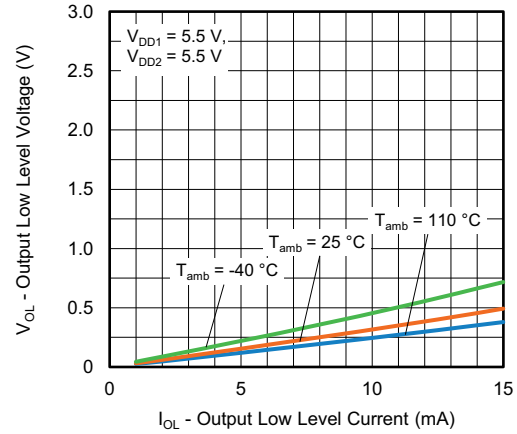


Fig. 14 - Output Low Level Voltage vs. Output Low Level Current

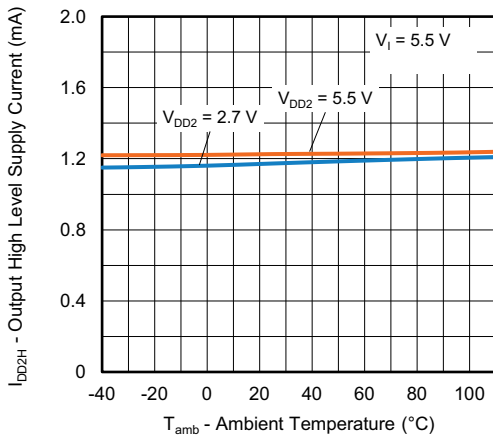


Fig. 12 - Output High Level Supply Current vs. Ambient Temperature

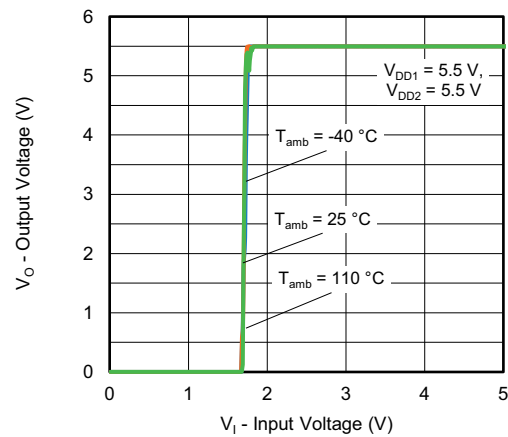


Fig. 15 - Output Voltage vs. Input Voltage

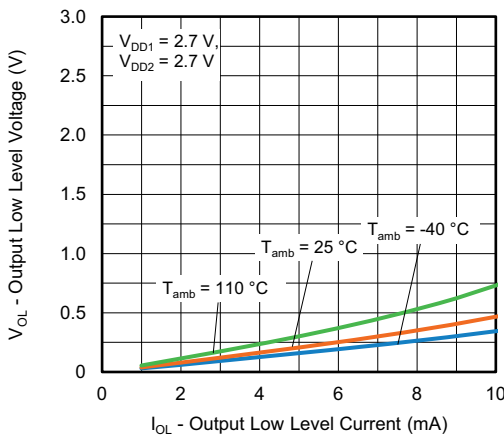


Fig. 13 - Output Low Level Voltage vs. Output Low Level Current

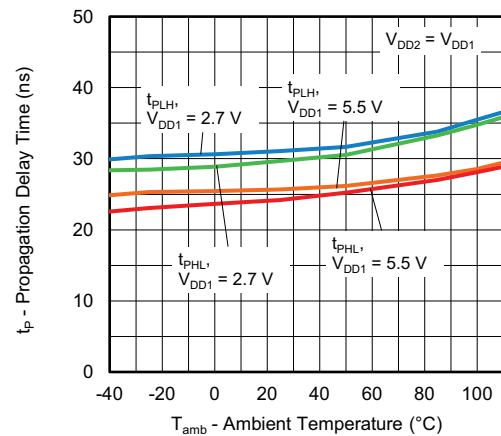


Fig. 16 - Propagation Delay Time vs. Ambient Temperature

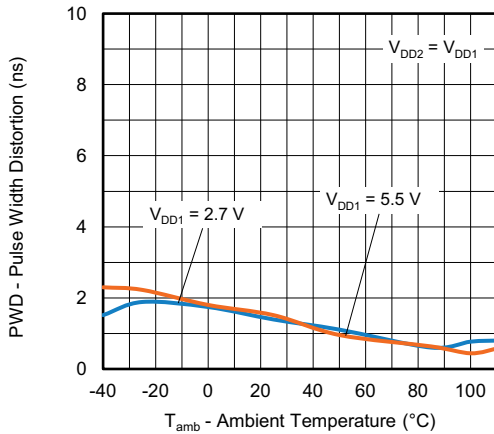


Fig. 17 - Pulse Width Distortion vs. Ambient Temperature

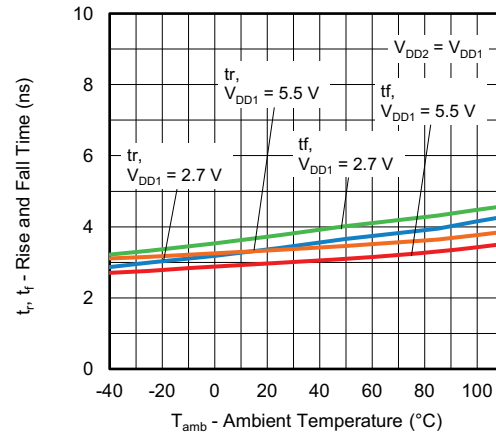
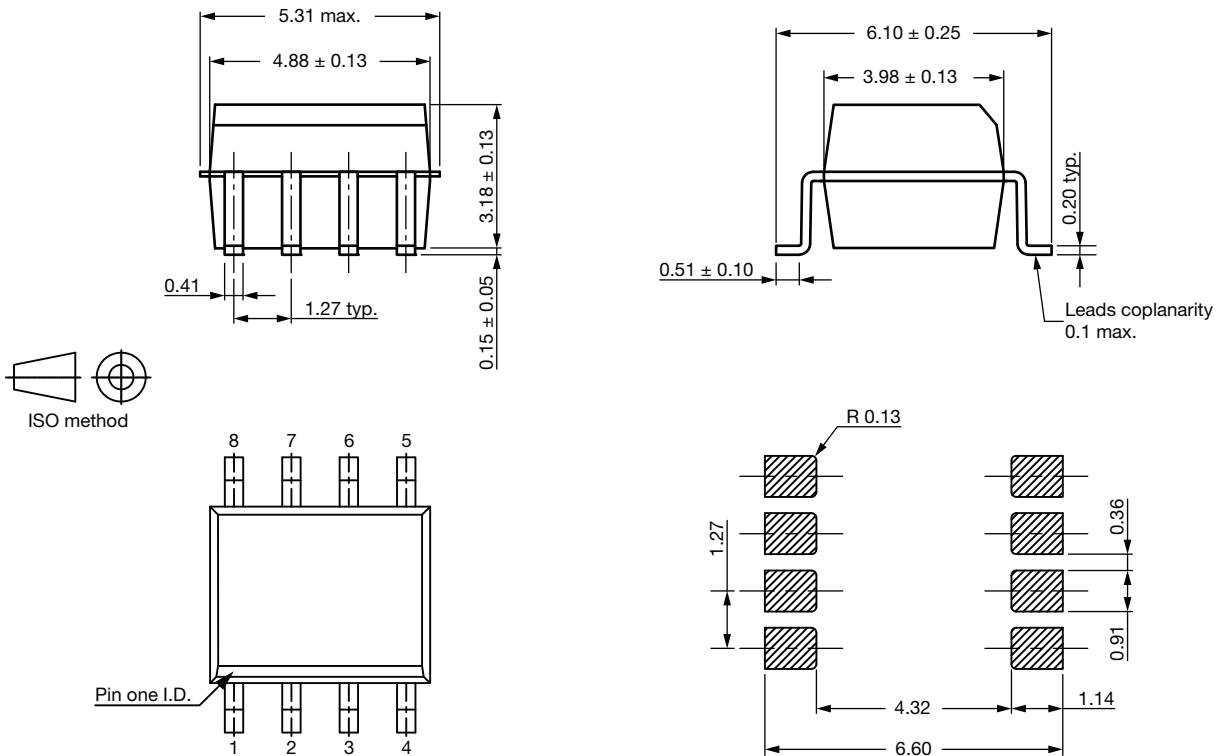


Fig. 18 - Rise and Fall Time vs. Ambient Temperature

**PACKAGE DIMENSIONS (in millimeters)**



Pin one I.D.

**PACKAGE MARKING**

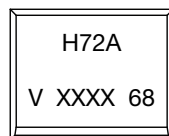


Fig. 19 - Example of VOIH72AT

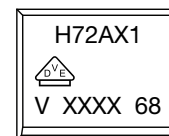


Fig. 20 - Example of VOIH72A-X001T

**Notes**

- XXXX = LMC (lot marking code)
- The VDE logo is only marked on option1 (-X001) parts
- Tape and reel suffix (T) is not part of the package marking

**PACKING INFORMATION** (in millimeters)

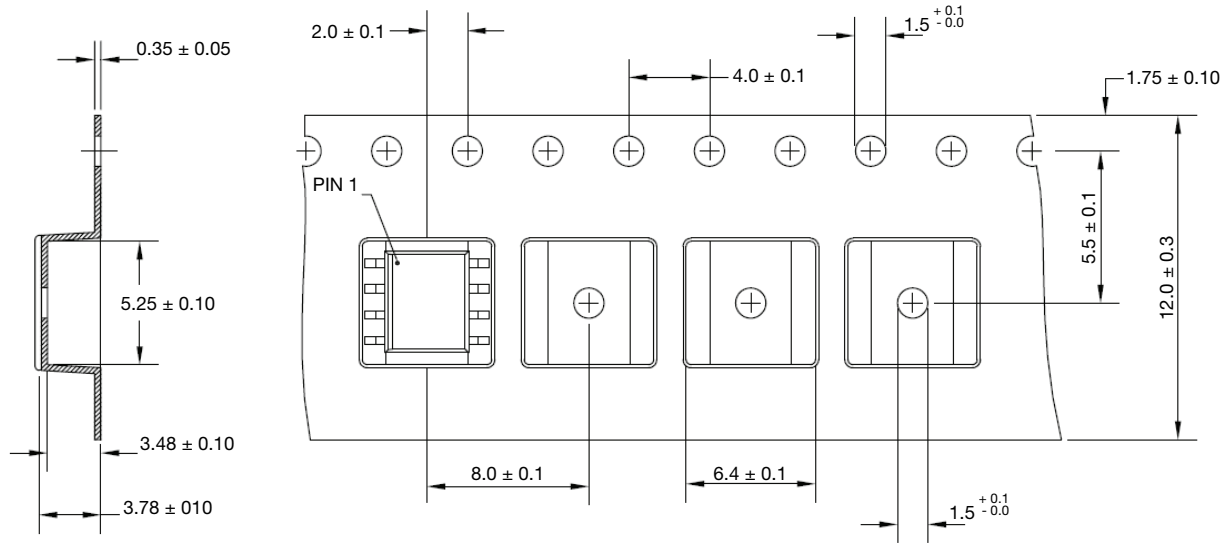
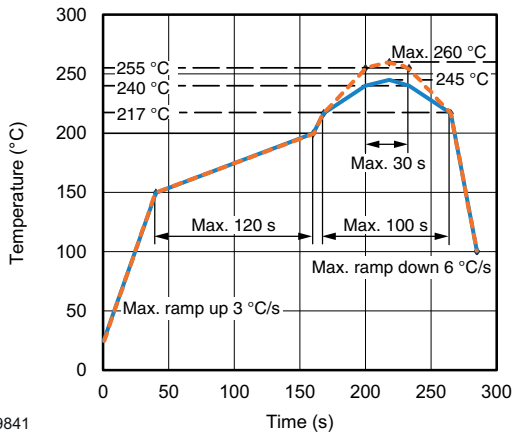


Fig. 21 - Tape and Reel Packing (2000 pieces on reel)

**SOLDER PROFILES**



19841

Fig. 22 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

**HANDLING AND STORAGE CONDITIONS**

ESD level: HBM class 2

Floor life: unlimited

Conditions:  $T_{amb} < 30\text{ }^{\circ}\text{C}$ , RH < 85 %

Moisture sensitivity level 1, according to J-STD-020

**ESD CAUTION**

This is an ESD (electro static discharge) sensitive device. Electrostatic charges accumulate on the human body and test equipment and can discharge without detection. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality. ESD withstand voltage of this device is up to 1500 V according to JESD22-A114-B.





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